



#6/Associate  
Dilling  
4-23-02  
HOO

PATENT  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

2823

Filing Date : 2001/3/29

Serial No. : 09/820,314

Docket No. : MXIP0026USA

Applicant : Jiann-Jen Chiou

Title : METHOD OF RINSING RESIDUAL ETCHING SOLUTION ON A  
SEMICONDUCTOR WAFER

To : Assistant Commissioner for Patents  
Washington, D.C. 20231

Subject : Authorization of Associate Agent

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MAR 27 2002  
Technology Center 2600

Dear Sir :

I hereby appoint Mord Michael Lewis, agent number 50,478, as my associate agent for  
the above-indicated application.

Winston Hsu

Date : 3/18/2002

Winston Hsu, Patent Agent No. 41,526

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